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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Application of: Meng Fei Koh, et al.
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Group Art Unit: TBA
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June 7, 2005

PRELIMINARY AMENDMENT A

TO THE COMMISSIONER FOR PATENTS,
SIR/MADAM:

Prior to examination and before calculation of the filing fee for the present application, please enter the following amendments and remarks.

Amendments to the specification begin on page 2 of this paper.

Amendments to the claims are reflected in the Listing of Claims, which begins on page 8 of this paper.

Remarks begin on page 12 of this paper.